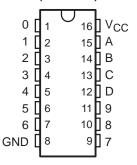
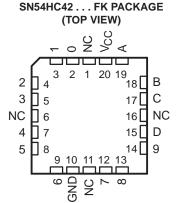
- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80-μA Max I_{CC}
- Typical t_{pd} = 14 ns
- ±4-mA Output Drive at 5 V

SN54HC42...J OR W PACKAGE SN74HC42...D, N, OR NS PACKAGE (TOP VIEW)



- Low Input Current of 1 μA Max
- Full Decoding of Input Logic
- All Outputs Are High for Invalid BCD Conditions
- Also for Applications as 3-Line to 8-Line Decoders



NC - No internal connection

description/ordering information

These decimal decoders consist of eight inverters and ten 4-input NAND gates. The inverters are connected in pairs to make BCD input data available for decoding by the NAND gates. Full decoding of valid input logic ensures that all inputs remain off for all invalid input conditions.

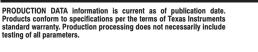
ORDERING INFORMATION

| TA | PACKA | GE [†] | ORDERABLE PART NUMBER | TOP-SIDE MARKING | | |
|----------------|-----------|-----------------|--------------------------|---------------------|--|--|
| | PDIP – N | Tube of 25 | SN74HC42N | SN74HC42N | | |
| | | Tube of 40 | SN74HC42D | | | |
| -40°C to 85°C | SOIC - D | Reel of 2500 | SN74HC42DR | HC42 | | |
| | | Reel of 250 | SN74HC42DT | | | |
| | SOP - NS | Reel of 2000 | SN74HC42NSR | HC42 | | |
| | CDIP – J | Tube of 25 | SNJ54HC42J | SNJ54HC42J | | |
| –55°C to 125°C | CFP – W | Tube of 150 | SNJ54HC42W | SNJ54HC42W | | |
| | LCCC – FK | Tube of 55 | SNJ54HC42FK | SNJ54HC42FK | | |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



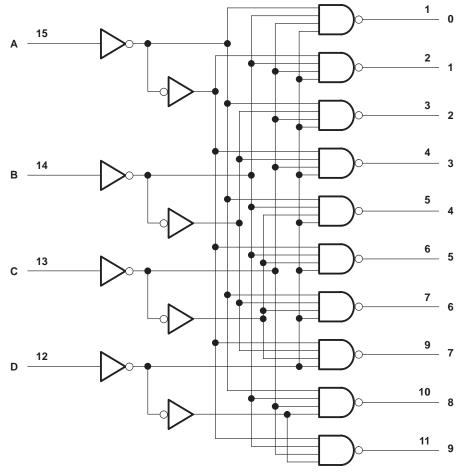
SN54HC42, SN74HC42 4-LINE TO 10-LINE DECODERS (1 of 10)

SCLS091D - DECEMBER 1982 - REVISED SEPTEMBER 2003

FUNCTION TABLE

| | | | | | | . 0.10 | IION IA | | | | | | | |
|-----------|---|-----|-----|---|---|--------|---------|---|------|------|---|---|---|---|
| | | INP | UTS | | | | | | OUTI | PUTS | | | | |
| NO. | D | С | В | Α | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
| 0 | L | L | L | L | L | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| 1 | L | L | L | Н | Н | L | Н | Н | Н | Н | Н | Н | Н | Н |
| 2 | L | L | Н | L | Н | Н | L | Н | Н | Н | Н | Н | Н | Н |
| 3 | L | L | Н | Н | Н | Н | Н | L | Н | Н | Н | Н | Н | Н |
| 4 | L | Н | L | L | Н | Н | Н | Н | L | Н | Н | Н | Н | Н |
| 5 | L | Н | L | Н | Н | Н | Н | Н | Н | L | Н | Н | Н | Н |
| 6 | L | Н | Н | L | Н | Н | Н | Н | Н | Н | L | Н | Н | Н |
| 7 | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | L | Н | Н |
| 8 | Н | L | L | L | Н | Н | Н | Н | Н | Н | Н | Н | L | Н |
| 9 | Н | L | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | L |
| | Н | L | Н | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| | Н | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| امنامينما | Н | Н | L | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| Invalid | Н | Н | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| | Н | Н | Н | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н |

logic diagram (positive logic)



Pin numbers shown are for the D, J, N, NS, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | | –0.5 V to 7 V |
|---|--|---------------|
| Input clamp current, I _{IK} (V _I < 0 or V _I > V _{CC}) (see | ee Note 1) | ±20 mA |
| Output clamp current, IOK (VO < 0 or VO > VCO | c) (see Note 1) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | - - • • • • • • • • • • • • • • • • • • | ±25 mA |
| Continuous current through V _{CC} or GND | | ±50 mA |
| Package thermal impedance, θ _{JA} (see Note 2) | : D package | 73°C/W |
| | N package | 67°C/W |
| | NS package | 64°C/W |
| Storage temperature range, T _{stg} | | |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 3)

| | | | S | N54HC4 | 2 | S | N74HC4 | 2 | |
|-------|---------------------------------|-------------------------|------|--------|------|------|--------|------|------|
| | | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | | 2 | 5 | 6 | 2 | 5 | 6 | V |
| | | V _{CC} = 2 V | 1.5 | | | 1.5 | | | |
| ViH | High-level input voltage | V _{CC} = 4.5 V | 3.15 | | | 3.15 | | | V |
| | | V _{CC} = 6 V | 4.2 | | | 4.2 | | | |
| | | V _{CC} = 2 V | | | 0.5 | | | 0.5 | |
| VIL | Low-level input voltage | V _{CC} = 4.5 V | | | 1.35 | | | 1.35 | V |
| | | VCC = 6 V | | | 1.8 | | | 1.8 | |
| VI | Input voltage | | 0 | | VCC | 0 | | VCC | V |
| VO | Output voltage | | 0 | | VCC | 0 | | VCC | V |
| | | V _{CC} = 2 V | | | 1000 | | | 1000 | |
| Δt/Δν | Input transition rise/fall time | V _{CC} = 4.5 V | | | 500 | | | 500 | ns |
| | | VCC = 6 V | | | 400 | | | 400 | |
| TA | Operating free-air temperature | · | -55 | | 125 | -40 | | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | 7507.00 | NIDITIONS. | ., | Т | A = 25°C | ; | SN54H | HC42 | SN74H | IC42 | LINIT |
|-----------|----------------------------|----------------------------|------------|------|----------|------|-------|-------|-------|-------|-------|
| PARAMETER | TEST CC | ONDITIONS | VCC | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | | |
| | | $I_{OH} = -20 \mu A$ | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | |
| ∨он | VI = VIH or VIL | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | V |
| | | $I_{OH} = -4 \text{ mA}$ | 4.5 V | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | $I_{OH} = -5.2 \text{ mA}$ | 6 V | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| | | | 2 V | | 0.002 | 0.1 | | 0.1 | | 0.1 | |
| | | I _{OL} = 20 μA | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| VoL | $V_I = V_{IH}$ or V_{IL} | | 6 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | V |
| | | I _{OL} = 4 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | 0.33 | |
| | | $I_{OL} = 5.2 \text{ mA}$ | 6 V | | 0.15 | 0.26 | | 0.4 | | 0.33 | |
| lį | $V_I = V_{CC}$ or 0 | | 6 V | | ±0.1 | ±100 | | ±1000 | | ±1000 | nA |
| ICC | $V_I = V_{CC}$ or 0, | IO = 0 | 6 V | | | 8 | | 160 | | 80 | μΑ |
| Ci | | | 2 V to 6 V | | 3 | 10 | | 10 | | 10 | pF |

VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| DADAMETER | FROM | TO (OUTPUT) | ., | T, | չ = 25°C | ; | SN54I | HC42 | SN74H | HC42 | LINIT |
|-----------------|---------------|----------------|-------|-----|----------|-----|-------|------|-------|------|-------|
| PARAMETER | (INPUT) | | VCC | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | 2 V | | 65 | 150 | | 225 | | 190 | |
| t _{pd} | A, B, C, or D | 0–9 | 4.5 V | | 18 | 30 | | 45 | | 38 | ns |
| · | | | 6 V | | 14 | 26 | | 38 | | 32 | |
| | | | 2 V | | 28 | 75 | | 110 | | 95 | |
| t _t | | Any | 4.5 V | | 8 | 15 | | 22 | | 19 | ns |
| | | | 6 V | | 7 | 13 | | 19 | | 16 | |

operating characteristics, T_A = 25°C

| | PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|-----------------|-----|------|
| C _{pd} | Power dissipation capacitance | No load | 39 | pF |

PARAMETER MEASUREMENT INFORMATION

VCC From Output Test Input 50% 50% **Under Test Point** C_L = 50 pF ^tPHL tPLH -(see Note A) V_{OH} In-Phase 50% 10% -Output **LOAD CIRCUIT** VOL - tPHL VCC VOH Input 50% Out-of-Phase Output 10% 10% VOL

NOTES: A. C_L includes probe and test-fixture capacitance.

VOLTAGE WAVEFORM

INPUT RISE AND FALL TIMES

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50~\Omega$, $t_f = 6$ ns, $t_f = 6$ ns.
- C. The outputs are measured one at a time with one input transition per measurement.
- D. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|---------------------------------------|---------|
| 5962-86821012A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 86821012A SNJ54HC 42FK | Samples |
| 5962-8682101EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8682101EA SNJ54HC42J | Samples |
| SN54HC42J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54HC42J | Samples |
| SN74HC42DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU SN | Level-1-260C-UNLIM | -40 to 85 | HC42 | Samples |
| SN74HC42N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 85 | SN74HC42N | Samples |
| SNJ54HC42FK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 86821012A SNJ54HC 42FK | Samples |
| SNJ54HC42J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8682101EA SNJ54HC42J | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

PACKAGE OPTION ADDENDUM

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54HC42, SN74HC42:

Catalog : SN74HC42

Military: SN54HC42

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

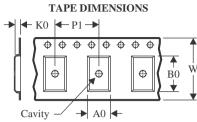
• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74HC42DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74HC42DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.6 | 9.3 | 2.1 | 8.0 | 16.0 | Q1 |

PACKAGE MATERIALS INFORMATION

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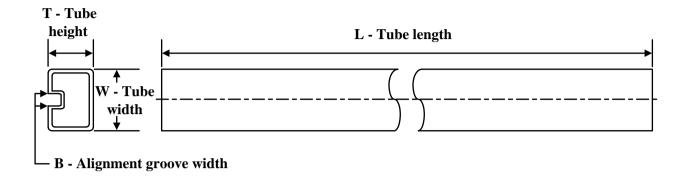
*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74HC42DR | SOIC | D | 16 | 2500 | 356.0 | 356.0 | 35.0 |
| SN74HC42DR | SOIC | D | 16 | 2500 | 366.0 | 364.0 | 50.0 |

PACKAGE MATERIALS INFORMATION

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TUBE

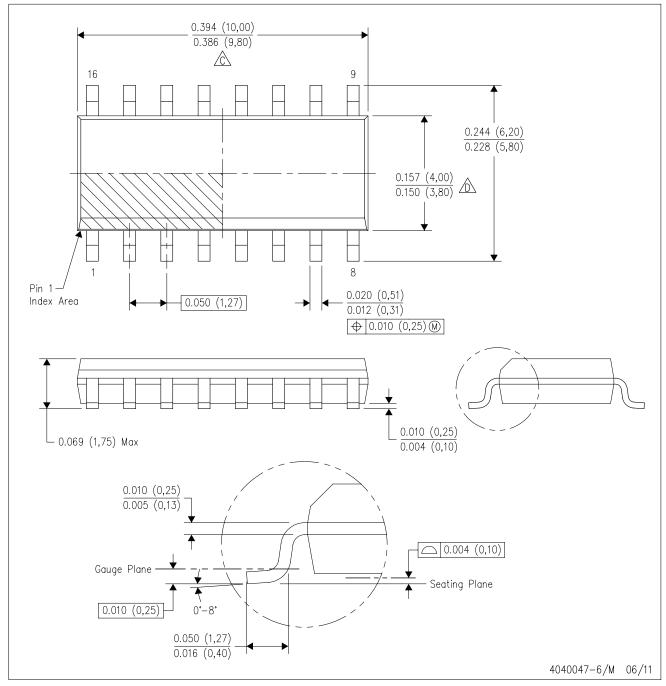


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-86821012A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| SN74HC42N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74HC42N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54HC42FK | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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